PCN Number:			20180320000			PCN Da	PCN Date: Marc			ch 22, 2018		
Title: Datasheet for LM5575-Q1												
Customer Contact:			PCN Manager							Dept:		Quality Services
Change Type:												
Assembly Site					Design					Wafer	Bump Site	
Assembly Process					\boxtimes	Data Sh	Data Sheet				Wafer	Bump Material
Assembly Materials						Part number change				<u></u>		Bump Process
Ш	Mechanical Specification			Test Site				<u> </u>		Fab Site		
Packing/Shipping/L			_abeling			Test Process				<u></u>		Fab Materials
											Fab Process	
	Notification Details											
Description of Change:												
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.												
TEXAS INSTRUMENTS LM5575-Q1 SNOSB23D - OCTOBER 2008 - REVISED MARCH 2018												
Changes from Revision C (December 2014) to Revision D Page												
Added links for WEBENCH; minor editorial updates for SEO improvement												
	Changed R _{MA} from "50°C/W" to "38.4°C/W" 5											
Changed R _{NC(top)} from "14°C/W" to "21.8°C/W"; add additional thermal values												
Consected unit for RL to "kΩ"												
	The datasheet number will be changing.											
Device Family						C	Change From:				Chang	e To:
LM5575-Q1						S	SNOSB23C			SNOSB23D		
These changes may be reviewed at the datasheet links provided.												
http://www.ti.com/product/LM5575-Q1												
Reason for Change:												
To accurately reflect device characteristics.												
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):												
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.												
Changes to product identification resulting from this PCN:												
No												
Pro	oduc	t Affected:										
LN	1557	5575Q0MH/NOPB LM5575Q0MHX/NOPB LM5575QMH/NOPB LM				15575QMHX/NOPB						

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com